

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Terry Sparks	01/03/2008
RECEIVING PARTY DATA	
Name:	Freescall Semiconductor, Inc.
Street Address:	6501 William Cannon West
Internal Address:	Law Dept.
City:	Austin
State/Country:	TEXAS
Postal Code:	78735
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11994764
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ATTORNEY DOCKET NUMBER:	SC13933CF
NAME OF SUBMITTER:	Stacie Herrera
Total Attachments: 2 source=SC13933CF-USA-Assignment#page1.tif source=SC13933CF-USA-Assignment#page2.tif	

CH 11994764 \$40.00

PATENT

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REEL: 020320 FRAME: 0841

ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I, **TERRY SPARKS, NISKAYUNA, NEW YORK** have sold, assigned and transferred, and do hereby sell, assign and transfer, unto **FREESCALE SEMICONDUCTOR, INC.**, a corporation of the State of Delaware, having its principal office in Austin, State of Texas, United States of America, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to an improvement in **METHOD AND APPARATUS FOR FORMING A NOBLE METAL LAYER, NOTABLY ON INLAID METAL FEATURES** (Docket No. SC13933CF), described, illustrated and claimed in an application for Letters Patent of the United States of America executed by me on the date indicated by my signature below, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation or reissue thereof.

I hereby also sell, assign and transfer unto **FREESCALE SEMICONDUCTOR, INC.**, the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and I further authorize **FREESCALE SEMICONDUCTOR, INC.** to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

I hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation or reissue, to **FREESCALE SEMICONDUCTOR, INC.**, for the sole use and benefit of **FREESCALE SEMICONDUCTOR, INC.**, its successors, assigns and legal representatives, to the full end of the term for which the Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and I hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to **FREESCALE SEMICONDUCTOR, INC.**

I agree that, when requested, I will, without charge to **FREESCALE SEMICONDUCTOR, INC.**, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in **FREESCALE SEMICONDUCTOR, INC.**, its successors, assigns and legal representatives or nominees.

I covenant with FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

Terry Sparks
TERRY SPARKS

DATE: 01-03-2008

First Witness

[Signature]
SIGNATURE OF WITNESS

DATE: 1-3-08
(Month-Day-Year)

PAIK LEUNG
PRINTED NAME OF WITNESS

Second Witness

[Signature]
SIGNATURE OF WITNESS

DATE: 1-3-08
(Month-Day-Year)

WILLARD E. CUMLEY
PRINTED NAME OF WITNESS